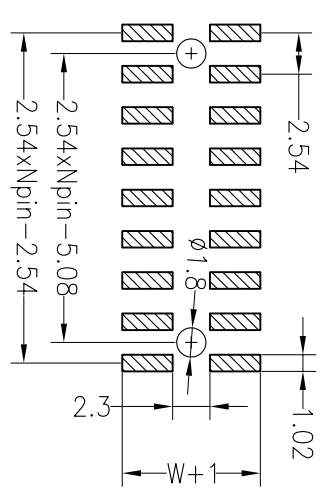
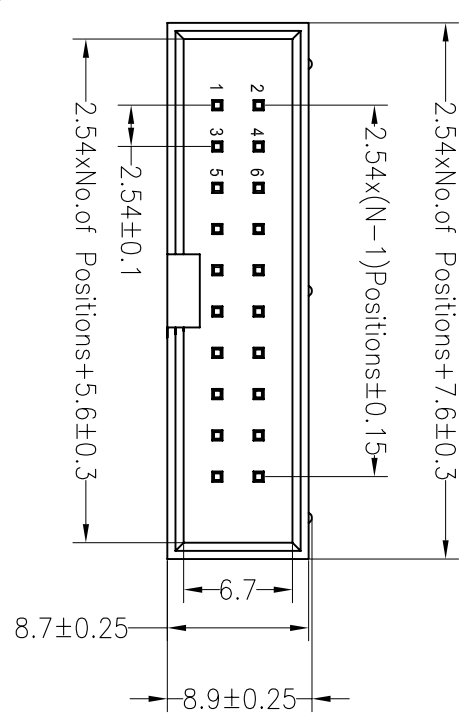


SPECIFICATIONS

Rated Current:3.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(Ul94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)

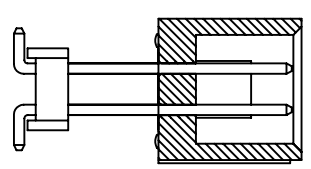
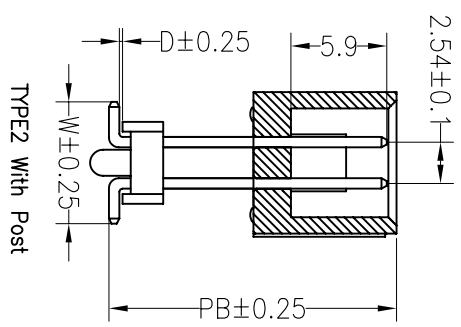
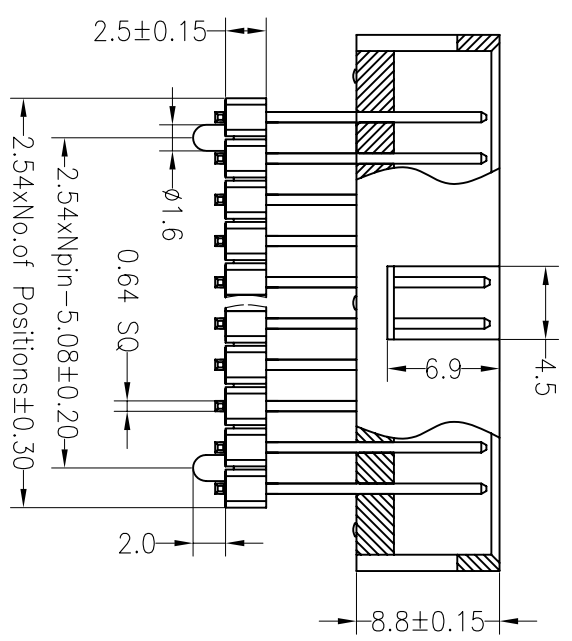
Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

3210 XX M XX X B D00 X 01(2)

No. of Pins: 6--64
 Contact Plating: G0:Gold Flash, G2:5U" Gold, G3:10U" Gold, G4:15U" Gold, G5:30U" Gold
 Insulator Material Option: A=BK-PBT, B=BK-PA66, C=BK-PA6T, D=BK-PA46, F=BK-LCP
 Packing: A=Tray, T=Tube, P=Tube+Cap, R=Reel+Cap, SN:Tin



Dimension anitheses list			
ITEM	PB	D	W
Standard		0.10	9.50
Alternate			

OPERATION		DRAW		SCALE		FIT		PART NO.	
X.X	±0.30	X.YuSheng	12.03.28	mm	A4	1/1	3210XXMXXXBDD00X01(2)	2.54mm Box Header H8.8mm+Pin Header SMT	
X.XX	±0.20	CHECK							
X.XXX	±0.10								
Angle	±3°	APPROVE							
DIM	TOL								
CHANGE		APPROVE		PROJ.		TITLE:		2.54mm Box Header H8.8mm+Pin Header SMT	
REV	DATE	MODIFICATION DESCRIPTION		CHANGE		DIM		TOL	
A0	2012.03.28	NEW DRAWING							
BESTCONN(WUHAN) TECHNOLOGY CO.,LTD https://bsconnector.com/									